Product data sheet

## 1. General description

The 74AVC1T1022 is a translating 1-to-4 fan-out buffer suitable for use in clock distribution. It has dual supplies ( $V_{CC(A)}$  and  $V_{CC(B)}$ ) for voltage translation. It also has a data input (A), four data outputs (1Yn and 2Yn) and an output enable input ( $\overline{OE}$ ).  $V_{CC(A)}$  and  $V_{CC(B)}$  can be independently supplied at any voltage between 0.8 V and 3.6 V. It makes the device suitable for low voltage translation between any of the following voltages: 0.8 V, 1.2 V, 1.5 V, 1.8 V, 2.5 V and 3.3 V. The levels of A,  $\overline{OE}$  and 1Yn are referenced to  $V_{CC(A)}$ , outputs 2Yn are referenced to  $V_{CC(B)}$ . This supply configuration ensures that two of the fanned out signals can be used in level shifting. A HIGH on  $\overline{OE}$  causes all outputs to be pulled LOW via pull-down resistors, a LOW on  $\overline{OE}$  disconnects the pull-down resistors and enables all outputs.

Schmitt trigger action at all inputs makes the circuit tolerant for slower input rise and fall time.

The I<sub>OFF</sub> circuitry disables the output, preventing any damaging backflow current through the device when it is powered down.

### 2. Features and benefits

- Wide supply voltage range:
  - V<sub>CC(A)</sub>: 0.8 V to 3.6 V
  - V<sub>CC(B)</sub>: 0.8 V to 3.6 V
- · Complies with JEDEC standards:
  - JESD8-12 (0.8 V to 1.3 V)
  - JESD8-11 (0.9 V to 1.65 V)
  - JESD8-7 (1.2 V to 1.95 V)
  - JESD8-5 (1.8 V to 2.7 V)
  - JESD8-B (2.7 V to 3.6 V)
- Maximum data rates:
  - 380 Mbit/s (≥ 1.8 V to 3.3 V translation)
  - 200 Mbit/s (≥ 1.1 V to 3.3 V translation)
  - 200 Mbit/s (≥ 1.1 V to 2.5 V translation)
  - 200 Mbit/s (≥ 1.1 V to 1.8 V translation)
  - 150 Mbit/s (≥ 1.1 V to 1.5 V translation)
  - 100 Mbit/s (≥ 1.1 V to 1.2 V translation)
- Latch-up performance exceeds 100 mA per JESD 78 Class II
- Inputs accept voltages up to 3.6 V
- ESD protection:
  - HBM: ANSI/ESDA/JEDEC JS-001 class 3B exceeds 8000 V
  - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1000 V
- Specified from -40 °C to +85 °C and -40 °C to +125 °C



# 3. Ordering information

#### **Table 1. Ordering information**

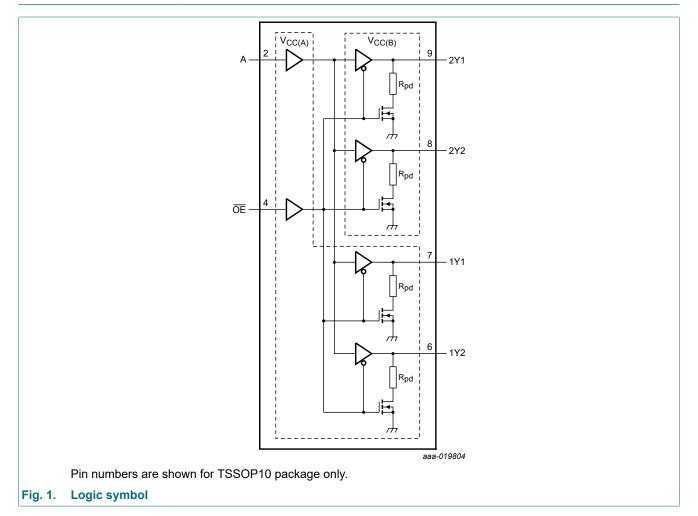
Type number	Package					
Temperature range Name Description						
74AVC1T1022DP	-40 °C to +125 °C	TSSOP10	plastic thin shrink small outline package; 10 leads; body width 3 mm	SOT552-1		
74AVC1T1022GU	-40 °C to +125 °C	XQFN10	plastic, extremely thin quad flat package; no leads; 10 terminals; body 1.40 × 1.80 × 0.50 mm	SOT1160-1		

# 4. Marking

### Table 2. Marking codes

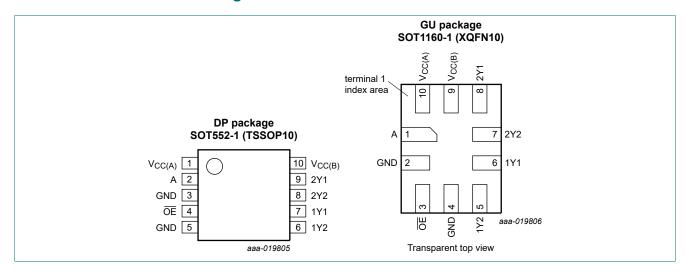
Type number	Marking code
74AVC1T1022DP	B2
74AVC1T1022GU	B2

# 5. Functional diagram



# 6. Pinning information

### 6.1. Pinning



## 6.2. Pin description

Table 3. Pin description

Symbol	Pin		Description
	SOT552-1 SOT1160-1		
V <sub>CC(A)</sub>	1	10	supply voltage A
Α	2	1	data input (referenced to V <sub>CC(A)</sub> )
GND[1]	3, 5	2, 4	ground (0 V)
ŌĒ	4	3	output enable input (active LOW) (referenced to V <sub>CC(A)</sub> )
1Y1, 1Y2	7, 6	6, 5	data outputs (referenced to V <sub>CC(A)</sub> )
2Y1, 2Y2	9, 8	8, 7	data outputs (referenced to V <sub>CC(B)</sub> )
V <sub>CC(B)</sub>	10	9	supply voltage B

<sup>[1]</sup> All GND pins must be connected to ground (0 V).

# 7. Functional description

#### **Table 4. Function table**

 $H = HIGH \ voltage \ level; \ L = LOW \ voltage \ level; \ X = don't \ care.$ 

Inputs	Output	
OE	A	nYn
L	L	L
L	Н	Н
Н	X	L

## 8. Limiting values

#### **Table 5. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>CC(A)</sub>	supply voltage A			-0.5	+4.6	V
V <sub>CC(B)</sub>	supply voltage B			-0.5	+4.6	V
VI	input voltage		[1]	-0.5	+4.6	V
Vo	output voltage	OE = LOW	[1] [2] [3]	-0.5	V <sub>CCO</sub> + 0.5	V
		ŌE = HIGH	[1]	-0.5	+4.6	V
I <sub>IK</sub>	input clamping current	V <sub>I</sub> < 0 V		-50	-	mA
I <sub>OK</sub>	output clamping current	V <sub>O</sub> < 0 V		-50	-	mA
Io	output current	V <sub>O</sub> = 0 V to V <sub>CCO</sub>	[2]	-	±50	mA
I <sub>CC</sub>	supply current	I <sub>CC(A)</sub> or I <sub>CC(B)</sub>		-	100	mA
$I_{GND}$	ground current			-100	-	mA
T <sub>stg</sub>	storage temperature			-65	+150	°C
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> = -40 °C to +125 °C	[4]	-	250	mW

<sup>[1]</sup> The minimum input voltage ratings and output voltage ratings may be exceeded if the input and output current ratings are observed.

## 9. Recommended operating conditions

Table 6. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC(A)</sub>	supply voltage A		0.8	3.6	V
V <sub>CC(B)</sub>	supply voltage B		0.8	3.6	V
VI	input voltage		0	3.6	V
Vo	output voltage	<u>OE</u> = LOW [1]	0	V <sub>cco</sub>	V
		OE = HIGH	0	3.6	V
T <sub>amb</sub>	ambient temperature		-40	+125	°C
Δt/ΔV	input transition rise and fall rate	V <sub>CC(A)</sub> =0.8 V to 3.6 V	0	200	ns/V

<sup>[1]</sup>  $V_{CCO}$  is the supply voltage associated with the output port.

<sup>[2]</sup> V<sub>CCO</sub> is the supply voltage associated with the output port.

<sup>[3]</sup>  $V_{CCO}$  + 0.5 V should not exceed 4.6 V.

<sup>[4]</sup> For SOT552-1 (TSSOP10) packages: P<sub>tot</sub> derates linearly with 8.3 mW/K above 120 °C. For SOT1160-1 (XQFN10) package: P<sub>tot</sub> derates linearly with 7.1 mW/K above 115 °C.

## 10. Static characteristics

#### **Table 7. Typical static characteristics**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Т	С	Unit	
			Min	Тур	Max	
V <sub>OH</sub>	HIGH-level output voltage	$V_I = V_{IH}$ or $V_{IL}$				
		$I_{O}$ = -1.5 mA; $V_{CC(A)} = V_{CC(B)} = 0.8 \text{ V}$	-	0.69	-	V
V <sub>OL</sub> LOW-level output voltage		$V_I = V_{IH}$ or $V_{IL}$				
		$I_{O} = 1.5 \text{ mA}; V_{CC(A)} = V_{CC(B)} = 0.8 \text{ V}$	-	0.07	-	V
I <sub>I</sub>	input leakage current	A, <del>OE</del> input; V <sub>I</sub> = 0 V or 3.6 V; V <sub>CC(A)</sub> = V <sub>CC(B)</sub> = 0.8 V to 3.6 V	-	±0.025	±0.25	μΑ
I <sub>OFF</sub>	power-off leakage current	$V_1$ or $V_0 = 0$ V to 3.6 V; $V_{CC(B)} = 0$ V; $V_{CC(A)} = 0.8$ V to 3.6 V	-	±0.1	±1	μA
R <sub>pd</sub>	pull-down resistance		-	50	-	kΩ
Cı	input capacitance	A, $\overline{OE}$ input; $V_I = 0 \text{ V or } 3.3 \text{ V}$ ; $V_{CC(A)} = V_{CC(B)} = 3.3 \text{ V}$	-	1.2	-	pF
Co	output capacitance	nYn; $V_O = 3.3 \text{ V or } 0 \text{ V}$ ; $V_{CC(A)} = V_{CC(B)} = 3.3 \text{ V}$	-	4.7	-	pF

#### **Table 8. Static characteristics**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	T <sub>amb</sub> = -40 °	°C to +85 °C	T <sub>an</sub> -40 °C to	Unit	
			Min	Max	Min	Max	
$V_{IH}$	HIGH-level input	A, OE input					
	voltage	V <sub>CC(A)</sub> = 0.8 V	0.70V <sub>CC(A)</sub>	-	0.70V <sub>CC(A)</sub>	-	V
		V <sub>CC(A)</sub> = 1.1 V to 1.95 V	0.65V <sub>CC(A)</sub>	-	0.65V <sub>CC(A)</sub>	-	V
		V <sub>CC(A)</sub> = 2.3 V to 2.7 V	1.6	-	1.6	-	V
		V <sub>CC(A)</sub> = 3.0 V to 3.6 V	2	-	2	-	V
$V_{IL}$	LOW-level input voltage	A, OE input					
		V <sub>CC(A)</sub> = 0.8 V	-	0.30V <sub>CC(A)</sub>	-	0.30V <sub>CC(A)</sub>	V
		V <sub>CC(A)</sub> = 1.1 V to 1.95 V	-	0.35V <sub>CC(A)</sub>	-	0.35V <sub>CC(A)</sub>	V
		$V_{CC(A)} = 2.3 \text{ V to } 2.7 \text{ V}$		0.7	-	0.7	V
		V <sub>CC(A)</sub> = 3.0 V to 3.6 V	-	0.8	-	0.8	V
V <sub>OH</sub>	HIGH-level output voltage	$V_I = V_{IH}$ or $V_{IL}$					
		$I_O = -100 \mu A;$ [1] $V_{CC(A)} = V_{CC(B)} = 0.8 \text{ V to } 3.6 \text{ V}$	V <sub>CCO</sub> - 0.1	-	V <sub>CCO</sub> - 0.1	-	V
		I <sub>O</sub> = -3 mA; V <sub>CC(A)</sub> = V <sub>CC(B)</sub> = 1.1 V	0.85	-	0.85	-	V
		$I_{O}$ = -6 mA; $V_{CC(A)} = V_{CC(B)} = 1.4 \text{ V}$	1.05	-	1.05	-	V
		I <sub>O</sub> = -8 mA; V <sub>CC(A)</sub> = V <sub>CC(B)</sub> = 1.65 V	1.2	-	1.2	-	V
		$I_{O}$ = -9 mA; $V_{CC(A)}$ = $V_{CC(B)}$ = 2.3 V	1.75	-	1.75	-	V
		$I_O = -12 \text{ mA};$ $V_{CC(A)} = V_{CC(B)} = 3.0 \text{ V}$	2.3	-	2.3	-	V

Symbol	Parameter	Conditions	T <sub>amb</sub> = -40	°C to +85 °C	T <sub>ai</sub> -40 °C to	Unit	
			Min	Max	Min	Max	
V <sub>OL</sub>	LOW-level output voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>					
		$I_O = 100 \mu A;$ $V_{CC(A)} = V_{CC(B)} = 0.8 \text{ V to } 3.6 \text{ V}$	-	0.1	-	0.1	V
		$I_{O}$ =-3 mA; $V_{CC(A)} = V_{CC(B)} = 1.1 \text{ V}$	-	0.25	-	0.25	V
		$I_{O}$ = 6 mA; $V_{CC(A)} = V_{CC(B)} = 1.4 \text{ V}$	-	0.35	-	0.35	V
		$I_{O} = 8 \text{ mA};$ $V_{CC(A)} = V_{CC(B)} = 1.65 \text{ V}$	-	0.45	-	0.45	V
		$I_O = 9 \text{ mA};$ $V_{CC(A)} = V_{CC(B)} = 2.3 \text{ V}$	-	0.55	-	0.55	V
		$I_O$ = 12 mA; $V_{CC(A)} = V_{CC(B)} = 3.0 \text{ V}$	-	0.7	-	0.7	V
I <sub>I</sub>	input leakage current	A, $\overline{OE}$ input; V <sub>I</sub> = 0 V or 3.6 V; V <sub>CC(A)</sub> = V <sub>CC(B)</sub> = 0.8 V to 3.6 V	-	±1	-	±5	μΑ
I <sub>OFF</sub>	power-off leakage current	1Yn; V <sub>I</sub> or V <sub>O</sub> = 0 V to 3.6 V; V <sub>CC(A)</sub> = 0 V; V <sub>CC(B)</sub> = 0.8 V to 3.6 V	-	±5	-	±30	μΑ
		2Yn; V <sub>I</sub> or V <sub>O</sub> = 0 V to 3.6 V; V <sub>CC(B)</sub> = 0 V; V <sub>CC(A)</sub> = 0.8 V to 3.6 V	-	±5	-	±30	μΑ
I <sub>CC(A)</sub>	supply current A	$V_{I} = 0 \text{ V or } V_{CC(A)}; I_{O} = 0 \text{ A}; \\ V_{CC(A)} = 0.8 \text{ V to } 3.6 \text{ V}; \\ V_{CC(B)} = 0.8 \text{ V to } 3.6 \text{ V}$	-	8	-	50	μΑ
I <sub>CC(B)</sub>	supply current B	$V_{I} = 0 \text{ V or } V_{CC(A)}; I_{O} = 0 \text{ A}; \\ V_{CC(A)} = 0.8 \text{ V to } 3.6 \text{ V}; \\ V_{CC(B)} = 0.8 \text{ V to } 3.6 \text{ V}$	-	8	-	50	μΑ

<sup>[1]</sup>  $V_{CCO}$  is the supply voltage associated with the output port.

# 11. Dynamic characteristics

Table 9. Typical power dissipation capacitance at  $T_{amb}$  = 25 °C

Symbol	Parameter	Conditions	[1]	$V_{CC(A)} = V_{CC(B)}$						Unit
		[2	[2]	0.8 V	1.2 V	1.5 V	1.8 V	2.5 V	3.3 V	
C <sub>PD</sub> power dissipation capacitance	1Yn; outputs enabled		17.6	18.4	18.5	18.8	20.6	23.5	pF	
	1Yn; outputs disabled		1.7	1.8	1.8	1.8	1.9	2.1	pF	
		2Yn; outputs enabled		17.2	17.9	18.0	18.3	19.9	22.8	pF
		2Yn; outputs disabled		1.1	1.2	1.2	1.2	1.3	1.4	pF

[1]  $\;\;C_{PD}$  is used to determine the dynamic power dissipation (PD in  $\mu W).$ 

 $P_D = C_{PD} \times V_{CC}^2 \times f_i + \Sigma (C_L \times V_{CC}^2 \times f_o)$  where:

f<sub>i</sub> = input frequency in MHz;

fo = output frequency in MHz;

C<sub>L</sub> = load capacitance in pF;

 $V_{CC}$  = supply voltage in V;  $\Sigma(C_L \times V_{CC}^2 \times f_0)$  = sum of the outputs. [2]  $f_i = 10$  MHz;  $V_I = GND$  to  $V_{CC(A)}$ ;  $t_r = t_f = 1$  ns;  $C_L = 0$  pF;  $R_L = \infty \Omega$ .

Table 10. Typical dynamic characteristics at  $V_{CC(A)}$  = 0.8 V and  $T_{amb}$  = 25 °C [1]

Voltages are referenced to GND (ground = 0 V); for test circuit, see Fig. 4; for waveforms, see Fig. 2 and Fig. 3.

Symbol	Parameter	Conditions	V <sub>CC(B)</sub>						Unit
			0.8 V	1.2 V	1.5 V	1.8 V	2.5 V	3.3 V	
t <sub>pd</sub>	propagation delay	A to 1Yn	23	23	23	23	23	23	ns
		A to 2Yn	23	14	12	12	12	12	ns
t <sub>dis</sub>	disable time	OE to 1Yn	20	20	20	20	20	20	ns
		OE to 2Yn	20	14	13	13	12	13	ns
t <sub>en</sub>	enable time	OE to 1Yn	25	25	25	25	25	25	ns
		OE to 2Yn	25	14	13	12	12	12	ns

<sup>[1]</sup>  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ ;  $t_{dis}$  is the same as  $t_{PLZ}$  and  $t_{PHZ}$ ;

Table 11. Typical dynamic characteristics at  $V_{CC(B)}$  = 0.8 V and  $T_{amb}$  = 25 °C [1]

Voltages are referenced to GND (ground = 0 V); for test circuit, see Fig. 4; for waveforms, see Fig. 2 and Fig. 3.

Symbol	Parameter	Conditions	V <sub>CC(A)</sub>						Unit
			0.8 V	1.2 V	1.5 V	1.8 V	2.5 V	3.3 V	
t <sub>pd</sub>	propagation delay	A to 1Yn	23	7.3	5.1	4.2	3.1	2.7	ns
		A to 2Yn	23	17	16	16	16	16	ns
t <sub>dis</sub>	disable time	OE to 1Yn	20	7.0	5.1	4.8	3.7	3.5	ns
		OE to 2Yn	20	14	14	13	13	13	ns
t <sub>en</sub>	enable time	OE to 1Yn	25	7.9	5.5	4.4	3.3	2.8	ns
		OE to 2Yn	25	20	19	19	18	18	ns

 $<sup>\</sup>begin{array}{ll} [1] & t_{pd} \text{ is the same as } t_{PLH} \text{ and } t_{PHL}; \\ & t_{dis} \text{ is the same as } t_{PLZ} \text{ and } t_{PHZ}; \\ & t_{en} \text{ is the same as } t_{PZL} \text{ and } t_{PZH}. \end{array}$ 

Table 12. Dynamic characteristics for temperature range -40 °C to +85 °C and -40 °C to +125 °C

Voltages are referenced to GND (ground = 0 V); for test circuit, see Fig. 4.

Symbol	Parameter	Conditions			$V_{CC(A)} = V_{CC(B)}$			Unit
			1.2 V ± 0.1 V	1.5 V ± 0.1 V	1.8 V ± 0.15 V	2.5 V ± 0.2 V	3.3 V ± 0.3 V	
			Max	Max	Max	Max	Max	
T <sub>amb</sub> = 2	5 °C							•
t <sub>sk(o)</sub>	output skew time	between any output	0.5	0.3	0.2	0.2	0.1	ns
T <sub>amb</sub> = -4	0 °C to +85 °C	;						
t <sub>sk(o)</sub>	output skew time	between any output	0.7	0.4	0.3	0.2	0.2	ns
T <sub>amb</sub> = -4	0 °C to +125 °	C.						
t <sub>sk(o)</sub>	output skew time	between any output	0.9	0.5	0.4	0.3	0.2	ns

 $t_{\text{en}}$  is the same as  $t_{\text{PZL}}$  and  $t_{\text{PZH}}$ .

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1-to-4 fan-out buffer

Table 13. Dynamic characteristics for temperature 25 °C [1]

Voltages are referenced to GND (ground = 0 V); for test circuit, see Fig. 4; for waveforms, see Fig. 2 and Fig. 3.

Symbol	Parameter	Conditions					Vc	C(B)					Unit
			1.2 V	± 0.1 V	1.5 V :	± 0.1 V		8 V 15 V	2.5 V	± 0.2 V	3.3 V	± 0.3 V	
			Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	
V <sub>CC(A)</sub> = '	1.1 V to 1.3 V								•				
t <sub>pd</sub>	propagation	A to 1Yn	2.0	13.5	2.0	13.5	2.0	13.5	2.0	13.5	2.0	13.5	ns
	delay	A to 2Yn	2.0	13.5	1.8	10.0	1.6	8.8	1.5	7.8	1.4	7.5	ns
t <sub>dis</sub>	disable time	OE to 1Yn	2.2	12.6	2.2	12.6	2.2	12.6	2.2	12.6	2.2	12.6	ns
		OE to 2Yn	2.2	12.6	1.9	10.3	2.0	10.2	1.8	9.2	2.1	10.0	ns
t <sub>en</sub>	enable time	OE to 1Yn	2.2	14.5	2.2	14.5	2.2	14.5	2.2	14.5	2.2	14.5	ns
		OE to 2Yn	2.2	14.5	1.9	10.5	1.7	9.2	1.5	8.0	1.5	7.6	ns
V <sub>CC(A)</sub> = '	1.4 V to 1.6 V	1						1	I		1		1
t <sub>pd</sub>	propagation	A to 1Yn	1.6	8.4	1.6	8.4	1.6	8.4	1.6	8.4	1.6	8.4	ns
	delay	A to 2Yn	1.8	12.0	1.6	8.4	1.4	7.2	1.3	5.9	1.2	5.4	ns
t <sub>dis</sub>	disable time	OE to 1Yn	1.8	8.1	1.8	8.1	1.8	8.1	1.8	8.1	1.8	8.1	ns
		OE to 2Yn	2.1	10.6	1.8	8.1	1.9	8.0	1.6	6.9	1.9	7.7	ns
t <sub>en</sub>	enable time	OE to 1Yn	1.7	8.7	1.7	8.7	1.7	8.7	1.7	8.7	1.7	8.7	ns
		OE to 2Yn	2.0	12.7	1.7	8.7	1.5	7.5	1.4	6.0	1.3	5.5	ns
V <sub>CC(A)</sub> = -	1.65 V to 1.95	V											1
t <sub>pd</sub>	propagation	A to 1Yn	1.3	6.6	1.3	6.6	1.3	6.6	1.3	6.6	1.3	6.6	ns
•	delay	A to 2Yn	1.8	11.4	1.5	7.8	1.3	6.6	1.1	5.2	1.1	4.7	ns
t <sub>dis</sub>	disable time	OE to 1Yn	1.8	7.4	1.8	7.4	1.8	7.4	1.8	7.4	1.8	7.4	ns
		OE to 2Yn	2.0	10.1	1.7	7.6	1.8	7.4	1.5	6.2	1.8	7.0	ns
t <sub>en</sub>	enable time	OE to 1Yn	1.4	6.8	1.4	6.8	1.4	6.8	1.4	6.8	1.4	6.8	ns
		OE to 2Yn	1.9	12.2	1.6	8.2	1.4	6.8	1.2	5.4	1.1	4.8	ns
$V_{CC(A)} = 2$	2.3 V to 2.7 V												1
t <sub>pd</sub>	propagation	A to 1Yn	1.1	4.6	1.1	4.6	1.1	4.6	1.1	4.6	1.1	4.6	ns
	delay	A to 2Yn	1.7	10.8	1.4	7.2	1.2	5.9	1.1	4.6	1.0	4.1	ns
t <sub>dis</sub>	disable time	OE to 1Yn	1.4	5.6	1.4	5.6	1.4	5.6	1.4	5.6	1.4	5.6	ns
		OE to 2Yn	1.9	9.6	1.6	6.9	1.7	6.8	1.4	5.6	1.7	6.3	ns
t <sub>en</sub>	enable time	OE to 1Yn	1.1	4.8	1.1	4.8	1.1	4.8	1.1	4.8	1.1	4.8	ns
<b></b>		OE to 2Yn	1.8	11.6	1.5	7.7	1.3	6.3	1.1	4.8	1.0	4.2	ns
V <sub>CC(A)</sub> = ;	3.0 V to 3.6 V												
t <sub>pd</sub>	propagation	A to 1Yn	0.9	3.9	0.9	3.9	0.9	3.9	0.9	3.9	0.9	3.9	ns
ρu	delay	A to 2Yn	1.6	10.6	1.4	7.0	1.2	5.7	1.0	4.4	0.9	3.9	ns
t <sub>dis</sub>	disable time	OE to 1Yn	1.6	6.0	1.6	6.0	1.6	6.0	1.6	6.0	1.6	6.0	ns
uis		OE to 2Yn	1.9	9.3	1.5	6.8	1.6	6.6	1.3	5.3	1.6	6.0	ns
t <sub>en</sub>	enable time	OE to 1Yn	1.0	4.0	1.0	4.0	1.0	4.0	1.0	4.0	1.0	4.0	ns
-दा।		OE to 2Yn	1.8	11.3	1.4	7.4	1.3	6.0	1.1	4.6	1.0	4.0	ns

 $<sup>\</sup>begin{array}{ll} [1] & t_{pd} \text{ is the same as } t_{PLH} \text{ and } t_{PHL}; \\ & t_{dis} \text{ is the same as } t_{PLZ} \text{ and } t_{PHZ}; \\ & t_{en} \text{ is the same as } t_{PZL} \text{ and } t_{PZH}. \end{array}$ 

Nexperia 74AVC1T1022

1-to-4 fan-out buffer

Table 14. Dynamic characteristics for temperature range -40 °C to +85 °C [1]

Voltages are referenced to GND (ground = 0 V); for test circuit, see Fig. 4; for waveforms, see Fig. 2 and Fig. 3.

Symbol	Parameter	Conditions					Vc	C(B)					Unit
			1.2 V	± 0.1 V	1.5 V	± 0.1 V		3 V 15 V	2.5 V	± 0.2 V	3.3 V	± 0.3 V	
			Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	
V <sub>CC(A)</sub> =	1.1 V to 1.3 V												
t <sub>pd</sub>	propagation	A to 1Yn	0.9	14.7	0.9	14.7	0.9	14.7	0.9	14.7	0.9	14.7	ns
	delay	A to 2Yn	0.9	14.7	0.8	11.2	0.7	9.9	0.6	8.8	0.6	8.5	ns
t <sub>dis</sub>	disable time	OE to 1Yn	1.0	14.7	1.0	14.7	1.0	14.7	1.0	14.7	1.0	14.7	ns
		OE to 2Yn	1.0	14.7	0.9	12.2	0.9	12.1	0.8	10.8	1.0	11.7	ns
t <sub>en</sub>	enable time	OE to 1Yn	1.0	15.8	1.0	15.8	1.0	15.8	1.0	15.8	1.0	15.8	ns
		OE to 2Yn	1.0	15.8	0.8	11.8	0.8	10.3	0.7	8.9	0.7	8.5	ns
V <sub>CC(A)</sub> =	1.4 V to 1.6 V												
t <sub>pd</sub>	propagation	A to 1Yn	0.7	9.5	0.7	9.5	0.7	9.5	0.7	9.5	0.7	9.5	ns
	delay	A to 2Yn	0.8	13.2	0.7	9.5	0.6	8.2	0.5	6.7	0.5	6.2	ns
t <sub>dis</sub>	disable time	OE to 1Yn	0.8	9.7	0.8	9.7	0.8	9.7	0.8	9.7	0.8	9.7	ns
		OE to 2Yn	0.9	12.4	0.8	9.7	0.8	9.7	0.7	8.3	0.9	9.0	ns
t <sub>en</sub>	enable time	OE to 1Yn	0.7	9.9	0.7	9.9	0.7	9.9	0.7	9.9	0.7	9.9	ns
		OE to 2Yn	0.9	14.0	0.7	9.9	0.7	8.5	0.6	6.9	0.6	6.2	ns
V <sub>CC(A)</sub> =	1.65 V to 1.95	V											.1
t <sub>pd</sub>	propagation	A to 1Yn	0.6	7.6	0.6	7.6	0.6	7.6	0.6	7.6	0.6	7.6	ns
•	delay	A to 2Yn	0.8	12.5	0.7	8.9	0.6	7.6	0.5	6.1	0.5	5.4	ns
t <sub>dis</sub>	disable time	OE to 1Yn	0.8	8.8	0.8	8.8	0.8	8.8	0.8	8.8	0.8	8.8	ns
		OE to 2Yn	0.9	11.7	0.8	9.0	0.8	8.8	0.7	7.4	0.8	8.2	ns
t <sub>en</sub>	enable time	OE to 1Yn	0.6	7.9	0.6	7.9	0.6	7.9	0.6	7.9	0.6	7.9	ns
		OE to 2Yn	0.8	13.5	0.7	9.3	0.6	7.9	0.6	6.3	0.5	5.6	ns
V <sub>CC(A)</sub> =	2.3 V to 2.7 V												
t <sub>pd</sub>	propagation	A to 1Yn	0.5	5.4	0.5	5.4	0.5	5.4	0.5	5.4	0.5	5.4	ns
	delay	A to 2Yn	0.8	12.0	0.6	8.3	0.6	6.9	0.5	5.4	0.4	4.7	ns
t <sub>dis</sub>	disable time	OE to 1Yn	0.6	6.5	0.6	6.5	0.6	6.5	0.6	6.5	0.6	6.5	ns
		OE to 2Yn	0.9	11.0	0.7	8.3	0.8	8.0	0.6	6.5	0.8	7.2	ns
t <sub>en</sub>	enable time	OE to 1Yn	0.5	5.5	0.5	5.5	0.5	5.5	0.5	5.5	0.5	5.5	ns
011		OE to 2Yn	0.8	12.8	0.7	8.7	0.6	7.3	0.5	5.5	0.5	4.8	ns
V <sub>CC(A)</sub> =	3.0 V to 3.6 V												
t <sub>pd</sub>	propagation	A to 1Yn	0.4	4.4	0.4	4.4	0.4	4.4	0.4	4.4	0.4	4.4	ns
ρū	delay	A to 2Yn	0.8	11.6	0.6	8.0	0.5	6.5	0.5	5.1	0.4	4.4	ns
t <sub>dis</sub>	disable time	OE to 1Yn	0.7	6.9	0.7	6.9	0.7	6.9	0.7	6.9	0.7	6.9	ns
uis		OE to 2Yn	0.9	10.8	0.7	8.0	0.7	7.7	0.6	6.2	0.7	6.9	ns
t <sub>en</sub>	enable time	OE to 1Yn	0.5	4.5	0.5	4.5	0.5	4.5	0.5	4.5	0.5	4.5	ns
en		OE to 2Yn	0.8	12.5	0.6	8.4	0.6	6.9	0.5	5.2	0.5	4.5	ns
		JE 10 2111	0.0	12.0	0.0	U. <del>T</del>	0.0	0.0	0.0	0.2	0.0	7.5	113

 $<sup>\</sup>begin{array}{ll} [1] & t_{pd} \text{ is the same as } t_{PLH} \text{ and } t_{PHL}; \\ & t_{dis} \text{ is the same as } t_{PLZ} \text{ and } t_{PHZ}; \\ & t_{en} \text{ is the same as } t_{PZL} \text{ and } t_{PZH}. \end{array}$ 

Nexperia 74AVC1T1022

1-to-4 fan-out buffer

Table 15. Dynamic characteristics for temperature range -40 °C to +125 °C [1]

Voltages are referenced to GND (ground = 0 V); for test circuit, see Fig. 4; for waveforms, see Fig. 2 and Fig. 3.

Symbol	Parameter	Conditions					Vc	C(B)					Unit
			1.2 V	± 0.1 V	1.5 V	± 0.1 V		3 V 15 V	2.5 V	± 0.2 V	3.3 V	± 0.3 V	
			Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	
V <sub>CC(A)</sub> =	1.1 V to 1.3 V												
t <sub>pd</sub>	propagation	A to 1Yn	0.9	15.7	0.9	15.7	0.9	15.7	0.9	15.7	0.9	15.7	ns
	delay	A to 2Yn	0.9	15.7	0.8	12.1	0.7	10.8	0.6	9.7	0.6	9.3	ns
t <sub>dis</sub>	disable time	OE to 1Yn	1.0	16.5	1.0	16.5	1.0	16.5	1.0	16.5	1.0	16.5	ns
		OE to 2Yn	1.0	16.5	0.9	13.8	0.9	13.7	0.8	12.3	1.0	13.1	ns
t <sub>en</sub>	enable time	OE to 1Yn	1.0	16.9	1.0	16.9	1.0	16.9	1.0	16.9	1.0	16.9	ns
		OE to 2Yn	1.0	16.9	0.8	12.9	0.8	11.4	0.7	9.7	0.7	9.2	ns
V <sub>CC(A)</sub> =	1.4 V to 1.6 V						ı		I				
t <sub>pd</sub>	propagation	A to 1Yn	0.7	10.4	0.7	10.4	0.7	10.4	0.7	10.4	0.7	10.4	ns
	delay	A to 2Yn	0.8	14.1	0.7	10.4	0.6	9.0	0.5	7.3	0.5	6.8	ns
t <sub>dis</sub>	disable time	OE to 1Yn	0.8	11.0	0.8	11.0	0.8	11.0	0.8	11.0	0.8	11.0	ns
		OE to 2Yn	0.9	14.0	0.8	11.0	0.8	11.0	0.7	9.5	0.9	10.2	ns
t <sub>en</sub>	enable time	OE to 1Yn	0.7	10.9	0.7	10.9	0.7	10.9	0.7	10.9	0.7	10.9	ns
		OE to 2Yn	0.9	15.1	0.7	10.9	0.7	9.3	0.6	7.6	0.6	6.8	ns
V <sub>CC(A)</sub> =	1.65 V to 1.95	v							I				
t <sub>pd</sub>	propagation	A to 1Yn	0.6	8.3	0.6	8.3	0.6	8.3	0.6	8.3	0.6	8.3	ns
	delay	A to 2Yn	0.8	13.6	0.7	9.7	0.6	8.3	0.5	6.7	0.5	6.0	ns
t <sub>dis</sub>	disable time	OE to 1Yn	0.8	10.0	0.8	10.0	0.8	10.0	0.8	10.0	0.8	10.0	ns
		OE to 2Yn	0.9	13.4	0.8	10.2	0.8	10.0	0.7	8.4	0.8	9.2	ns
t <sub>en</sub>	enable time	OE to 1Yn	0.6	8.7	0.6	8.7	0.6	8.7	0.6	8.7	0.6	8.7	ns
		OE to 2Yn	0.9	14.5	0.7	10.2	0.6	8.7	0.6	6.9	0.5	6.2	ns
V <sub>CC(A)</sub> =	2.3 V to 2.7 V								ı				
t <sub>pd</sub>	propagation	A to 1Yn	0.5	5.9	0.5	5.9	0.5	5.9	0.5	5.9	0.5	5.9	ns
	delay	A to 2Yn	0.8	12.9	0.6	9.1	0.6	7.6	0.5	5.9	0.4	5.2	ns
t <sub>dis</sub>	disable time	OE to 1Yn	0.6	7.5	0.6	7.5	0.6	7.5	0.6	7.5	0.6	7.5	ns
		OE to 2Yn	0.9	12.5	0.7	9.4	0.8	9.1	0.6	7.5	0.8	8.2	ns
t <sub>en</sub>	enable time	OE to 1Yn	0.5	6.1	0.5	6.1	0.6	6.1	0.6	6.1	0.6	6.1	ns
		OE to 2Yn	0.8	13.7	0.7	9.5	0.6	8.0	0.5	6.1	0.5	5.3	ns
V <sub>CC(A)</sub> =	3.0 V to 3.6 V												
t <sub>pd</sub>	propagation	A to 1Yn	0.4	4.9	0.4	4.9	0.4	4.9	0.4	4.9	0.4	4.9	ns
	delay	A to 2Yn	0.8	12.5	0.6	8.7	0.5	7.2	0.5	5.6	0.4	4.9	ns
t <sub>dis</sub>	disable time	OE to 1Yn	0.7	7.7	0.7	7.7	0.7	7.7	0.7	7.7	0.7	7.7	ns
		OE to 2Yn	0.9	12.1	0.7	9.1	0.7	8.8	0.6	7.1	0.7	7.7	ns
t <sub>en</sub>	enable time	OE to 1Yn	0.5	4.9	0.5	4.9	0.5	4.9	0.5	4.9	0.5	4.9	ns
		OE to 2Yn	0.8	13.4	0.6	9.2	0.6	7.6	0.5	5.7	0.5	4.9	ns

 $<sup>\</sup>begin{array}{ll} [1] & t_{pd} \text{ is the same as } t_{PLH} \text{ and } t_{PHL}; \\ & t_{dis} \text{ is the same as } t_{PLZ} \text{ and } t_{PHZ}; \\ & t_{en} \text{ is the same as } t_{PZL} \text{ and } t_{PZH}. \end{array}$ 

### 11.1. Waveforms and test circuit

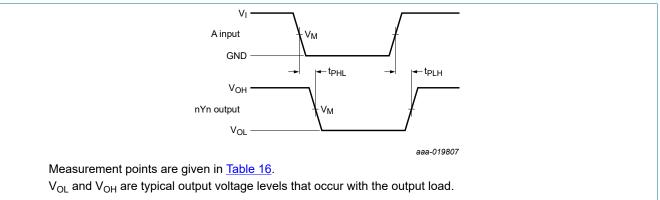


Fig. 2. The data input (A) to output (nYn) propagation delay times

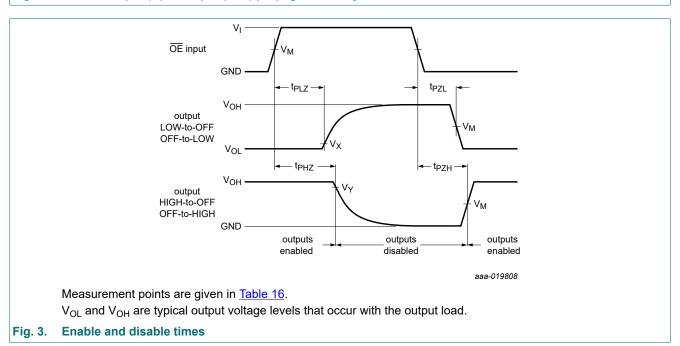
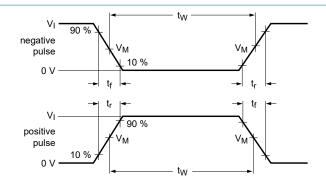
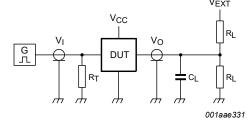


Table 16. Measurement points

Table 101 Meadardi	Total points							
Supply voltage	Input	Output						
V <sub>CC(A)</sub> , V <sub>CC(B)</sub>	V <sub>M</sub>	V <sub>M</sub> [1]	V <sub>X</sub>	V <sub>Y</sub>				
0.8 V to 1.6 V	0.5 × V <sub>CC(A)</sub>	0.5 × V <sub>CCO</sub>	V <sub>OL</sub> + 0.1 V	V <sub>OH</sub> - 0.1 V				
1.65 V to 2.7 V	0.5 × V <sub>CC(A)</sub>	0.5 × V <sub>CCO</sub>	V <sub>OL</sub> + 0.15 V	V <sub>OH</sub> - 0.15 V				
3.0 V to 3.6 V	0.5 × V <sub>CC(A)</sub>	0.5 × V <sub>CCO</sub>	V <sub>OL</sub> + 0.3 V	V <sub>OH</sub> - 0.3 V				

[1]  $V_{CCO}$  is the supply voltage associated with the output port.





Test data is given in Table 17

Definitions test circuit:

R<sub>L</sub> = Load resistance;

 $C_L$  = Load capacitance including jig and probe capacitance;

R<sub>T</sub> = Termination resistance;

 $V_{\text{EXT}}$  = External voltage for measuring switching times.

Fig. 4. Test circuit for measuring switching times

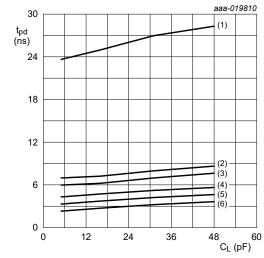
Table 17. Test data

	-								
Supply voltage	Input		Load		V <sub>EXT</sub>	V <sub>EXT</sub>			
V <sub>CC(A)</sub> , V <sub>CC(B)</sub>	VI	Δt/ΔV[1]	CL	R <sub>L</sub>	t <sub>PLH</sub> , t <sub>PHL</sub>	t <sub>PZH</sub> , t <sub>PHZ</sub>	t <sub>PZL</sub> , t <sub>PLZ</sub> [2]		
0.8 V to 1.6 V	V <sub>CC(A)</sub>	≤ 1.0 ns/V	15 pF	2 kΩ	open	GND	2 × V <sub>CCO</sub>		
1.65 V to 2.7 V	V <sub>CC(A)</sub>	≤ 1.0 ns/V	15 pF	2 kΩ	open	GND	2 × V <sub>CCO</sub>		
3.0 V to 3.6 V	V <sub>CC(A)</sub>	≤ 1.0 ns/V	15 pF	2 kΩ	open	GND	2 × V <sub>CCO</sub>		

<sup>[1]</sup> dV/dt ≥ 1.0 V/ns

[2] V<sub>CCO</sub> is the supply voltage associated with the output port.

# 12. Typical propagation delay characteristics



a. Propagation delay (A to 1Yn)



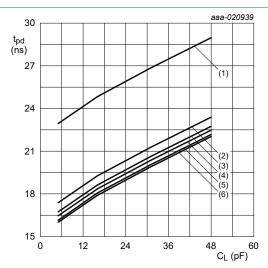
(2) 
$$V_{CC(A)} = 1.2 \text{ V}.$$

(3) 
$$V_{CC(A)} = 1.5 \text{ V}.$$

(4) 
$$V_{CC(A)} = 1.8 \text{ V}.$$

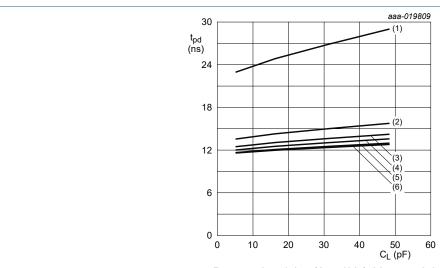
(5) 
$$V_{CC(A)} = 2.5 \text{ V}.$$

(6) 
$$V_{CC(A)} = 3.3 \text{ V}.$$



b. Propagation delay (A to 2Yn);  $V_{CC(B)} = 0.8 \text{ V}$ 





a. Propagation delay (A to 2Yn); V<sub>CC(A)</sub> = 0.8 V

(1) 
$$V_{CC(B)} = 0.8 \text{ V}.$$

(2) 
$$V_{CC(B)} = 1.2 \text{ V}.$$

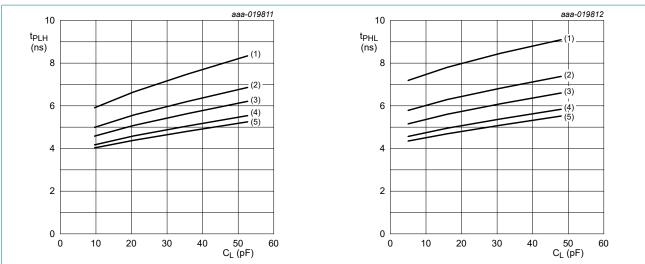
(3) 
$$V_{CC(B)} = 1.5 \text{ V}.$$

(4) 
$$V_{CC(B)} = 1.8 \text{ V}.$$

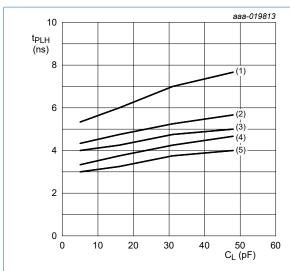
(5) 
$$V_{CC(B)} = 2.5 \text{ V}.$$

(6) 
$$V_{CC(B)} = 3.3 \text{ V}.$$

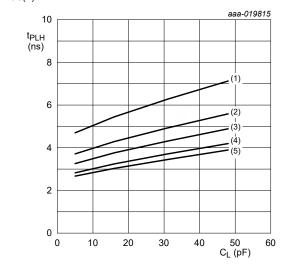
Fig. 6. Typical propagation delay versus load capacitance; T<sub>amb</sub> = 25 °C



- a. LOW to HIGH propagation delay (A to 2Yn);  $V_{CC(A)} = 1.2 \text{ V}$  b. HIGH to LOW propagation delay (A to 2Yn);  $V_{CC(A)} = 1.2 \text{ V}$ 
  - (1)  $V_{CC(B)} = 1.2 \text{ V}.$
  - (2)  $V_{CC(B)} = 1.5 \text{ V}.$
  - (3)  $V_{CC(B)} = 1.8 \text{ V}.$
  - (4)  $V_{CC(B)} = 2.5 \text{ V}.$
  - (5)  $V_{CC(B)} = 3.3 \text{ V}.$
- Fig. 7. Typical propagation delay versus load capacitance; T<sub>amb</sub> = 25 °C



a. LOW to HIGH propagation delay (A to 2Yn);  $V_{CC(A)} = 1.5 \text{ V}$ 



c. LOW to HIGH propagation delay (A to 2Yn);

 $V_{CC(A)} = 1.8 \text{ V}$ 

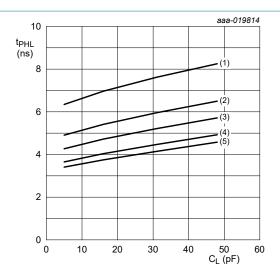
(1)  $V_{CC(B)} = 1.2 \text{ V}.$ 

(2)  $V_{CC(B)} = 1.5 \text{ V}.$ 

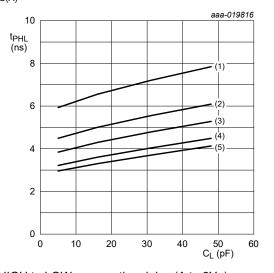
(3)  $V_{CC(B)} = 1.8 \text{ V}.$ 

(4)  $V_{CC(B)} = 2.5 \text{ V}.$ 

(5)  $V_{CC(B)} = 3.3 \text{ V}.$ 



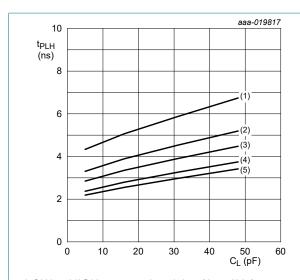
b. HIGH to LOW propagation delay (A to 2Yn);  $V_{CC(A)} = 1.5 \text{ V}$ 



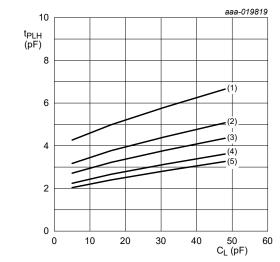
d. HIGH to LOW propagation delay (A to 2Yn);  $V_{CC(A)} = 1.8 \text{ V}$ 

Fig. 8. Typical propagation delay versus load capacitance; T<sub>amb</sub> = 25 °C

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a. LOW to HIGH propagation delay (A to 2Yn);  $V_{CC(A)} = 2.5 \text{ V}$ 



c. LOW to HIGH propagation delay (A to 2Yn);  $V_{CC(A)} = 3.3 \text{ V}$ 

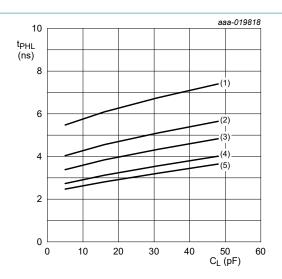


(2)  $V_{CC(B)} = 1.5 \text{ V}.$ 

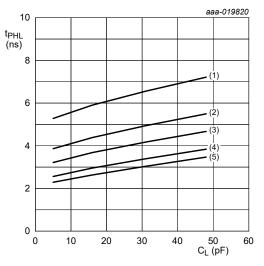
(3)  $V_{CC(B)} = 1.8 \text{ V}.$ 

(4)  $V_{CC(B)} = 2.5 \text{ V}.$ 

(5)  $V_{CC(B)} = 3.3 \text{ V}.$ 



b. HIGH to LOW propagation delay (A to 2Yn);  $V_{CC(A)} = 2.5 \text{ V}$ 



d. HIGH to LOW propagation delay (A to 2Yn);  $V_{\text{CC(A)}}$  = 3.3 V

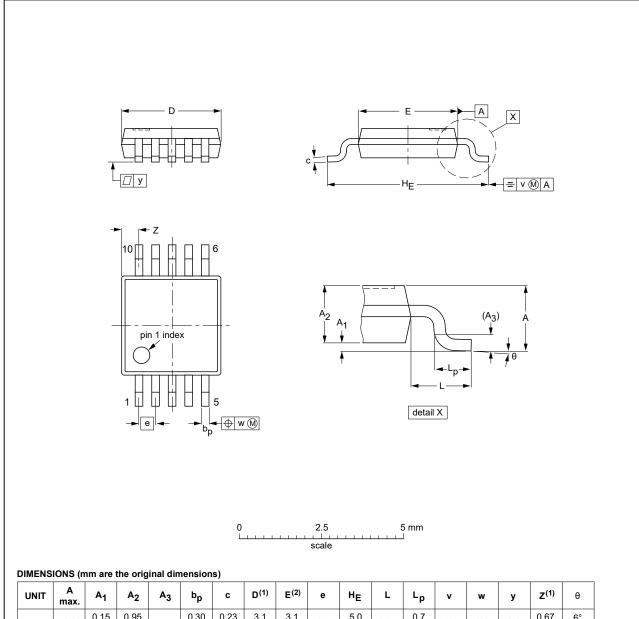
Fig. 9. Typical propagation delay versus load capacitance; T<sub>amb</sub> = 25 °C

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# 13. Package outline

### TSSOP10: plastic thin shrink small outline package; 10 leads; body width 3 mm

SOT552-1



UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	А3	bp	С	D <sup>(1)</sup>	E <sup>(2)</sup>	е	HE	L	Lp	v	w	у	Z <sup>(1)</sup>	θ
mm	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.15	0.23 0.15	3.1 2.9	3.1 2.9	0.5	5.0 4.8	0.95	0.7 0.4	0.1	0.1	0.1	0.67 0.34	6° 0°

#### Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
SOT552-1					<del>99-07-29</del> 03-02-18

Fig. 10. Package outline SOT552-1 (TSSOP10)

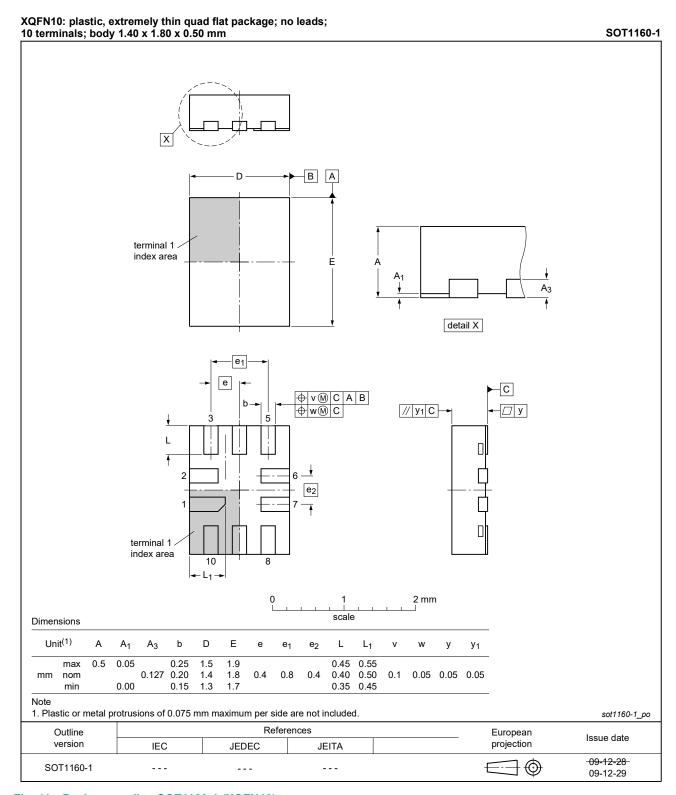


Fig. 11. Package outline SOT1160-1 (XQFN10)

## 14. Abbreviations

#### **Table 18. Abbreviations**

Acronym	Description
ANSI	American National Standards Institute
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
ESDA	ElectroStatic Discharge Association
НВМ	Human Body Model
JEDEC	Joint Electron Device Engineering Council

# 15. Revision history

#### **Table 19. Revision history**

Document ID	Release date	Data sheet status	Change notice	Supersedes
74AVC1T1022 v.3	20240625	Product data sheet	-	74AVC1T1022 v.2
Modifications:		ESD specification updated and ESD specification updated and ESD specification updated are specified as a specific specif	•	
74AVC1T1022 v.2	20170316	Product data sheet	-	74AVC1T1022 v.1
Modifications:	guidelines	of this data sheet has beer of Nexperia. have been adapted to the	J	
74AVC1T1022 v.1	20151207	Product data sheet	-	-

## 16. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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